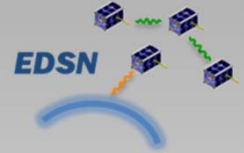




44th International Conference on
Environmental Systems



Thermal Modeling and Testing of the Edison Demonstration of Smallsat Networks Project

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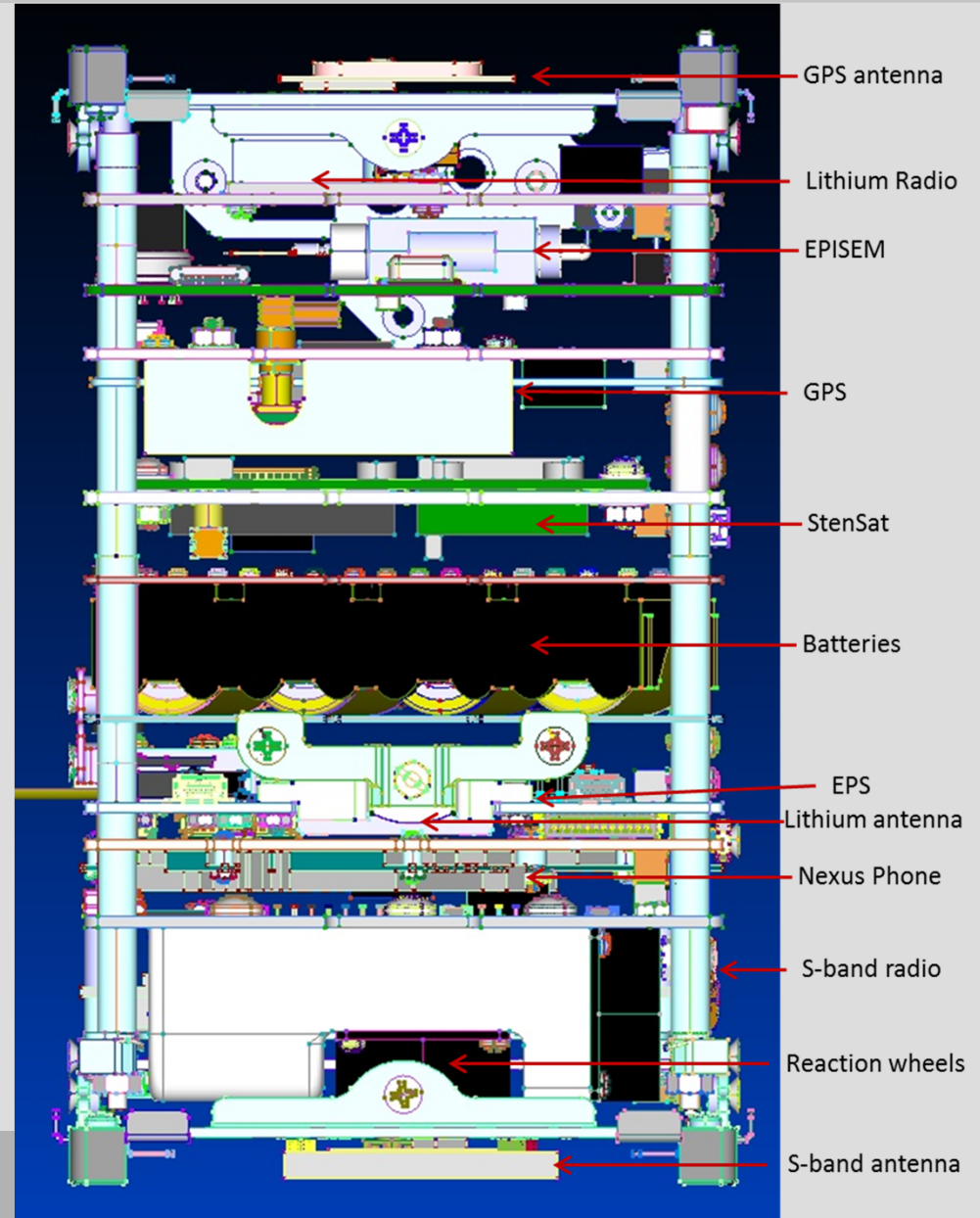
July 13-17, 2014

Introduction to EDSN

- NASA will be launching a swarm of 8 1.5U 2kg cubesats (EDSN) similar to the PhoneSats (launched over the last two years)
- Launching on new Super Strypi vehicle in November 2014 as the secondary payload
- Nominally into a circular near-polar ~500 km orbit
- Primary mission is to demonstrate intra-swarm communications
- Multi-point in-situ data acquisition (EPISEM)

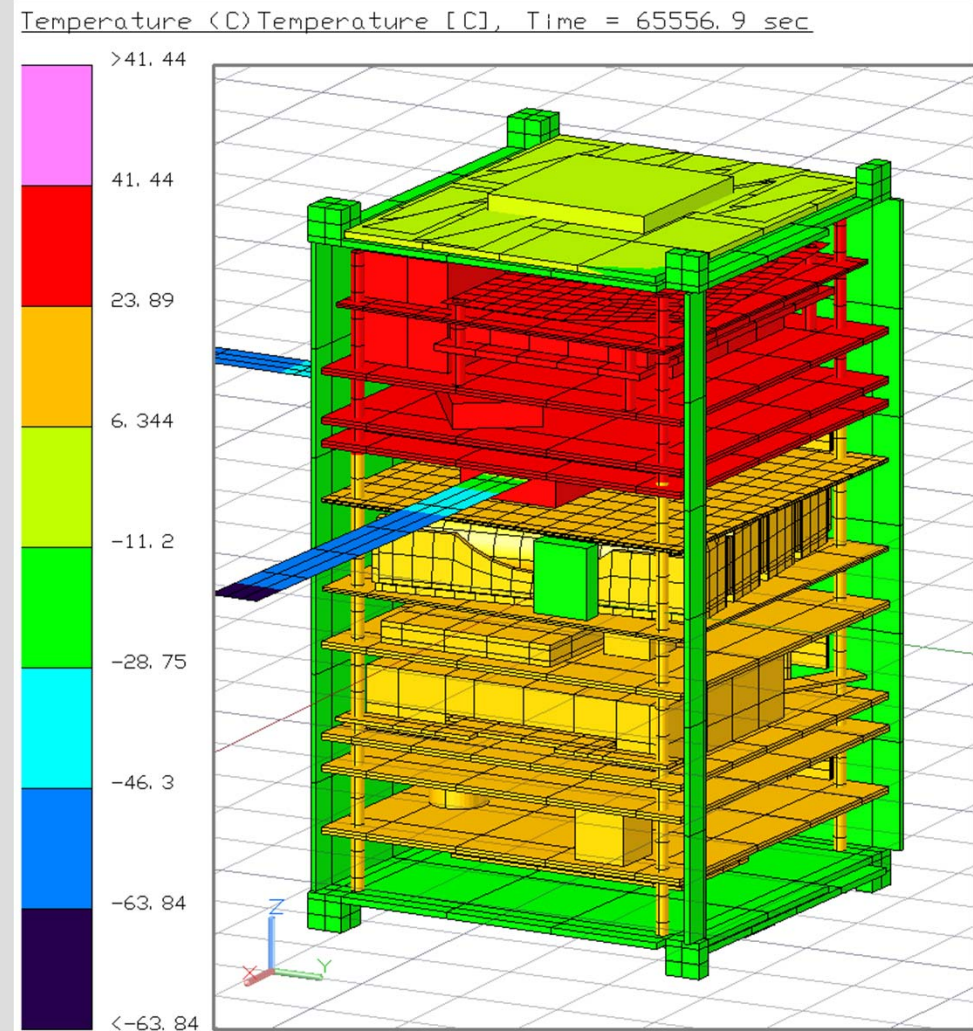
Thermal Issues

- Entirely passive
- Exterior covered in solar cells and magnetorquers
- Duty cycles highly variable
- Thermal analysis needed
 - Nominal not conservative
 - Unknown contacts
 - Uncharacterized materials
 - No subsystem TVAC testing
- Geometrically accurate thermal model constructed from CAD file



Thermal Model (1)

- Imported into and run in Thermal Desktop
- Accurate thermal mass
- Geometries simplified
- Some details (wires, screws, standoffs, etc.) ignored
- Only some thermal and optical properties known
- Only ~2 W of solar power
- Time-dependent heat loads for powered components and batteries (~20 Wh)

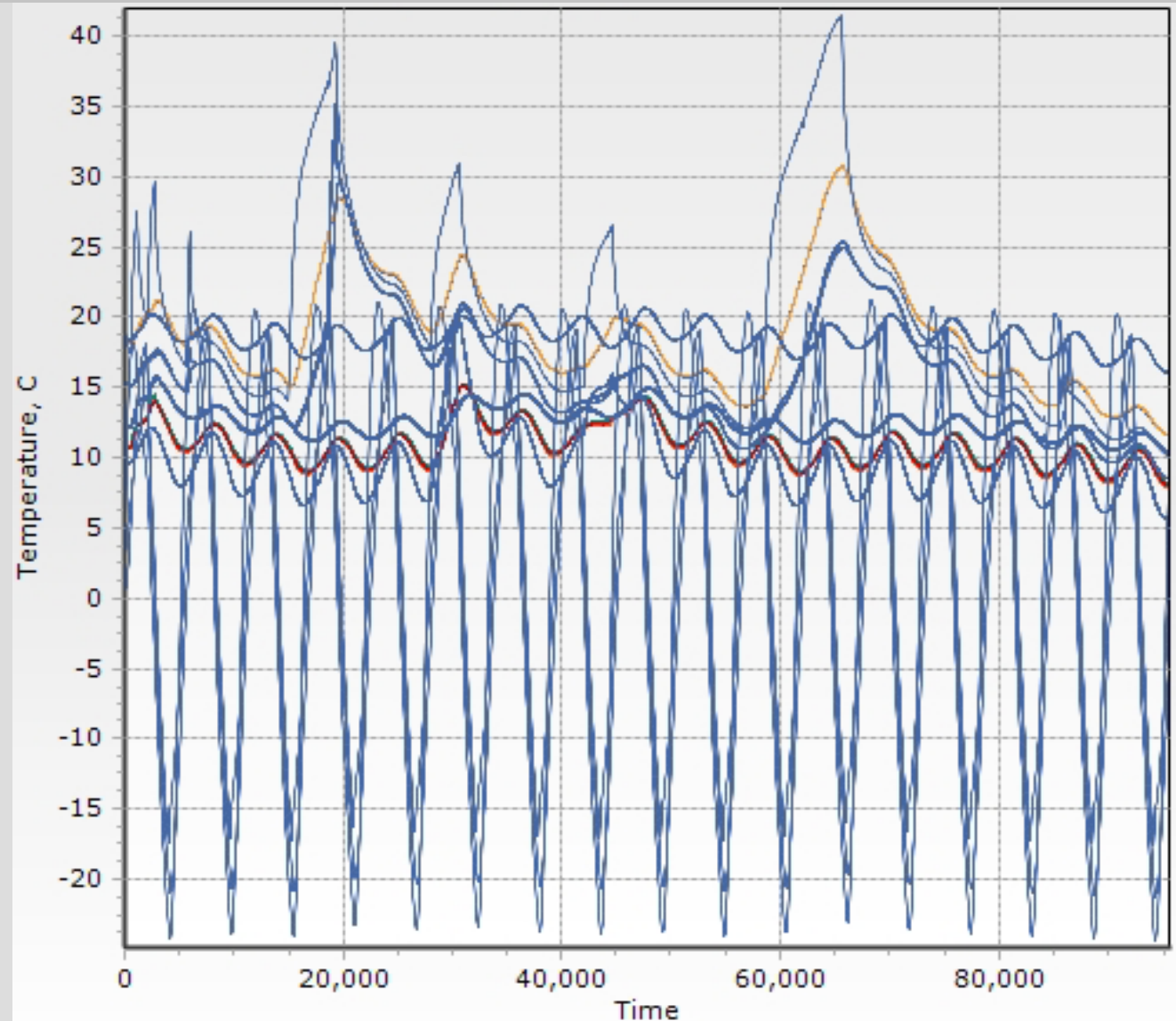


Thermal Model (2)

- Each model ran seventeen 94 minute nominal orbits
 - maximum (30°) and minimum (0°) beta angle
 - Eclipses: 36% to 38% of orbit
 - Orbit-averaged albedo (30% and 25%)
 - Solar (1414/1322) and earth IR (240/218) maximum and minimum flux values
 - Different spacecraft orientations (magnetic field aligned)
 - Stabilized (S-band antenna towards earth)
 - Rapidly spinning in all 3 axes (reduces extremes by $\sim +5/-2^{\circ}\text{C}$)
 - Different heat load duty cycles (many potential combinations during operations due to downlink)
- Determined bounding temperatures for components

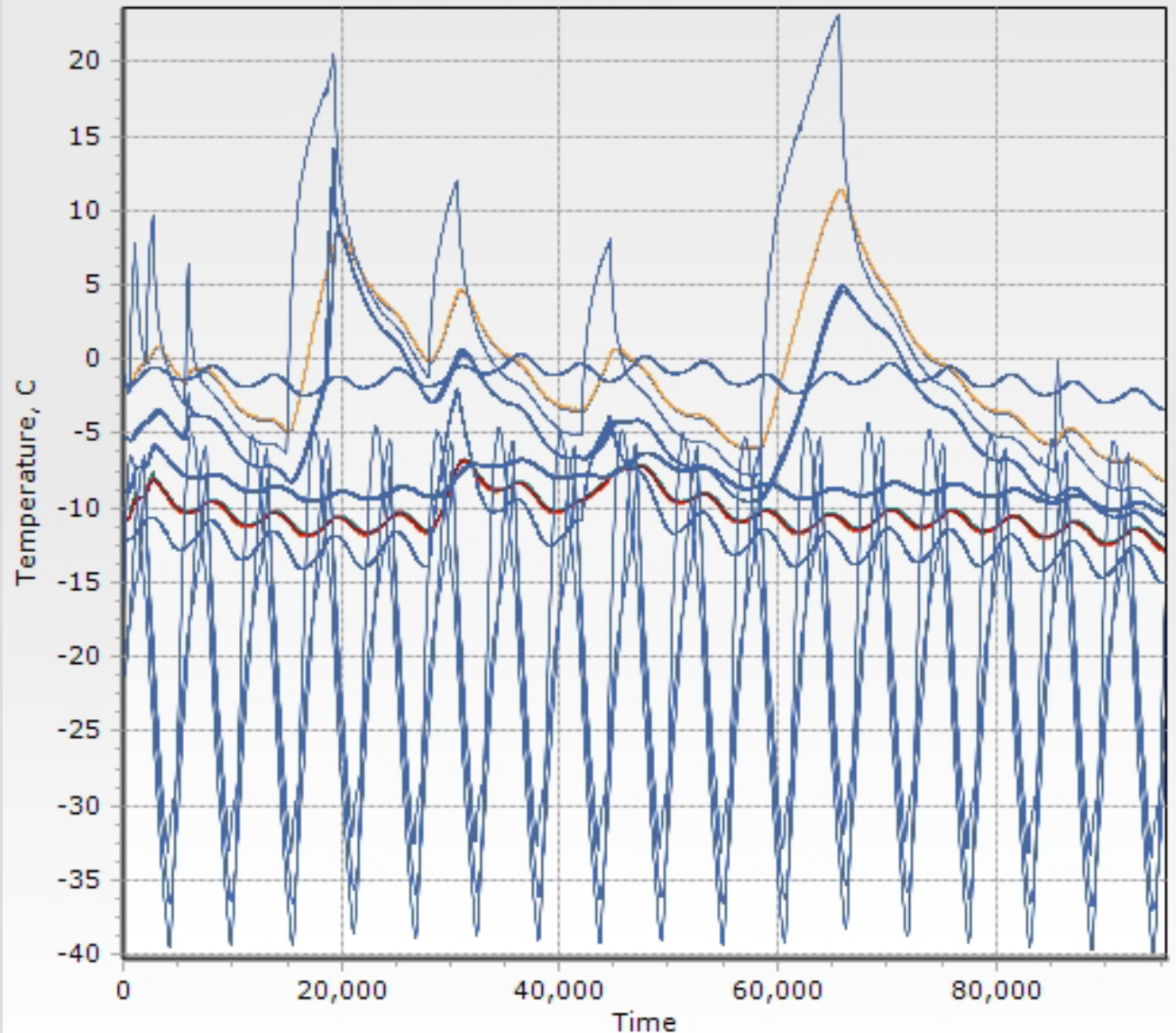
Results (hot case)

- Stabilized orientation
- Maximum orbital environments
- Chassis, MTs, SPs not included in plot
- Patch antennas have $\sim 50^{\circ}\text{C}$ thermal cycle
- Phone & S-band transceiver reach $\sim 40^{\circ}\text{C}$
- Worse if extended detumble or alignment downlink needed



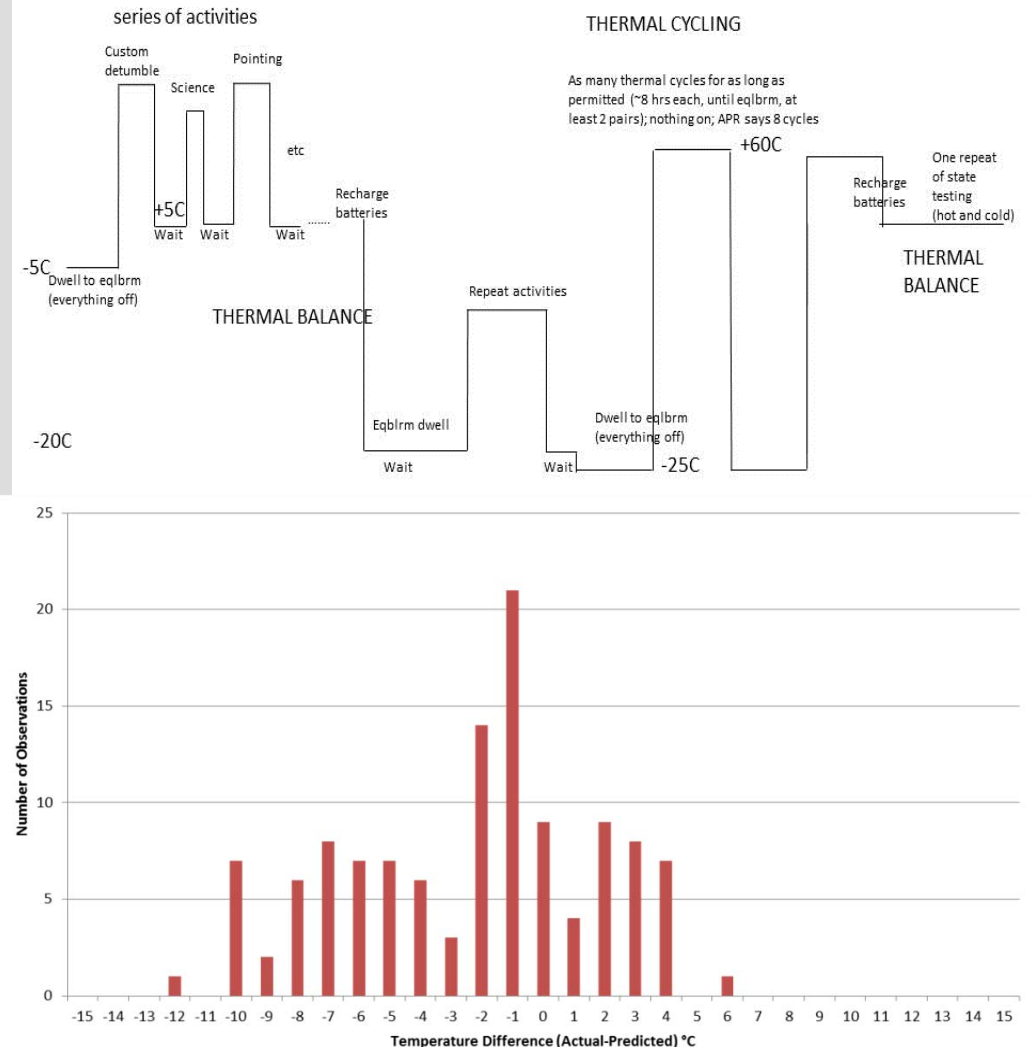
Results (cold case)

- Stabilized orientation
- No internal components colder than -15°C
 - All cold operation limits $< -20^{\circ}\text{C}$
 - Except batteries...
- External surfaces get to $\sim -40^{\circ}\text{C}$
 - Potential SP TC cycling issues
- TMs (not shown) have $\sim 120^{\circ}\text{C}$ thermal cycle



TVAC

- Could not 'test as fly'
 - Limited resources
 - No radio transmissions
 - Simple chamber thermal controls
- Power dissipation determined from TVAC results
 - Total average 4.6W dissipation (>25% drop)
- Nominal 0+/-5°C non-op environment
- TVAC results showed major issue with thermal models: PCB grounding planes
- Chassis cutouts not in model, so tape added



Summary (hot)

- Copper grounding planes:
 - 10x higher conductivity in PCBs so heat carried away
- With $\sim 10^{\circ}\text{C}$ margin, no overheating issues
- Caveats:
 - Orbit change of beta (not launching at local noon)
 - Substantial conops changes

Summary (cold)

- May have degraded oscillator behavior
- Likely have degraded battery behavior
 - At $\sim -10^{\circ}\text{C}$ off nominal cold case, deemed acceptable
- Patch antennas near cold op limit
 - But just not tested to those limits
- TM antennas cycle from -80 to $+50^{\circ}\text{C}$
- Otherwise, have $\sim 20^{\circ}\text{C}$ margin
- Caveats:
 - Extended non-op periods

Conclusions

- Thermal Desktop modeling of the EDSN spacecraft shows no significant thermal concerns
- Some components are 'near' their temperature limits in extreme cases, but the risk is deemed minimal and acceptable
- Loss of battery efficiency due to low ($<0^{\circ}\text{C}$) temperatures deemed acceptable

Lessons Learned for Cubesats

- 1) Communication is key – always ask for confirmation of even the most obvious thing
- 2) You never know your orbit until launch since you are the secondary payload
- 3) Pictures are not as good as seeing the hardware for yourself
- 4) Thermal imaging though helpful, easy, and cheap, can be very misleading
- 5) Things – almost *every* thing – will change
- 6) Inspection of ‘good’ results are minimal while ‘bad’ results result in more work
- 7) Do not assume others read what you write
- 8) Nomenclature is important so state terms, do not assume
- 9) No subsystem testing means uncertainty in inputs before testing of the ‘final’ SC
- 10) Beware ‘instincts’: One thermal analyst’s ‘meh’ is another’s ‘eep’
- 11) A limit may not mean a limit, but, rather, ignorance
- 12) But most importantly.....

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Trust no one